4-Bit Binary Full Adder with Fast Carry

The SN74LS283 is a high-speed 4-Bit Binary Full Adder with internal carry lookahead. It accepts two 4-bit binary words (A_1-A_4, B_1-B_4) and a Carry Input (C_0) . It generates the binary Sum outputs $(\sum_1-\sum_4)$ and the Carry Output (C_4) from the most significant bit. The LS283 operates with either active HIGH or active LOW operands (positive or negative logic).

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current - High			-0.4	mA
I _{OL}	Output Current – Low			8.0	mA



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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 648



SOIC D SUFFIX CASE 751B



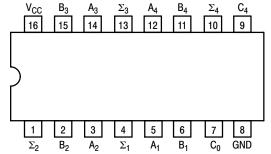
SOEIAJ M SUFFIX CASE 966

ORDERING INFORMATION

Device	Package	Shipping		
SN74LS283N	16 Pin DIP	2000 Units/Box		
SN74LS283D	SOIC-16	38 Units/Rail		
SN74LS283DR2	SOIC-16	2500/Tape & Reel		
SN74LS283M	SOEIAJ-16	See Note 1		
SN74LS283MEL	SOEIAJ-16	See Note 1		

For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:

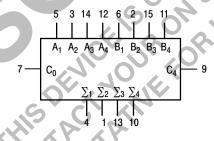
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

	LOA			NG	i (Note a)
PIN NAMES			HIGH		LOW
A ₁ - A ₄	Operand A Inputs		1.0 U.L.		0.5 U.L.
B ₁ - B ₄	Operand B Inputs		1.0 U.L.		0.5 U.L.
C_0	Carry Input		0.5 U.L.		0.25 U.L.
Σ_1 - Σ_4	Sum Outputs		10 U.L.		5 U.L.
C ₄	Carry Output	4	10 U.L.		5 U.L.

NOTES:

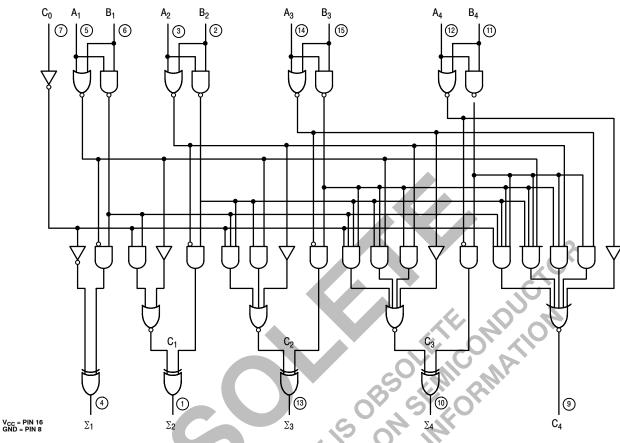
a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

LOGIC SYMBOL



V_{CC} = PIN 1

LOGIC DIAGRAM



= PIN NUMBERS

FUNCTIONAL DESCRIPTION

The LS283 adds two 4-bit binary words (A plus B) plus the incoming carry. The binary sum appears on the sum outputs $(\sum_1 - \sum_4)$ and outgoing carry (C4) outputs.

$$C_0 + (A_1 + B_1) + 2(A_2 + B_2) + 4(A_3 + B_3) + 8(A_4 + B_4) = \sum_1 + 2$$

 $\sum_2 + 4 \sum_3 + 8 \sum_4 + 16C_4$

Where: (+) = plus

Due to the symmetry of the binary add function the LS283 can be used with either all inputs and outputs active HIGH (positive logic) or with all inputs and outputs active LOW (negative logic). Note that with active HIGH inputs, Carry Input can not be left open, but must be held LOW when no carry in is intended.

Example:

	Co	A_1	A ₂	A ₃	A_4	B ₁	B ₂	B ₃	B ₄	Σ1	Σ_{2}	∑з	Σ4	C ₄	
logic levels	L	L	Н	L	Н	Н	L	L	Н	Н	Н	L	L	Н	
Active HIGH	0	0	1	0	1	1	0	0	1	1	1	0	0	1	
Active LOW	1	1	0	1	0	0	1	1	0	0	0	1	1	0	ĺ

(10+9=19) (carry+5+6=12)

Interchanging inputs of equal weight does not affect the operation, thus C₀, A₁, B₁, can be arbitrarily assigned to pins 7, 5 or 3.

FUNCTIONAL TRUTH TABLE

C (n-1)	A _n	B _n	Σ_{n}	C _n
L	L	L	L	L
L	L	Н	Н	L
L	Н	L	Н	L
L	Н	Н	L	Н
Н	L	L	Н	L
Н	L	Н	L	Н
Н	Н	L	L	Н
Н	Н	Н	Н	Н

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

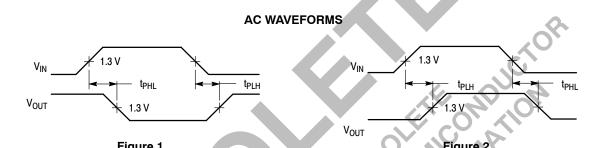
			Limits				
Symbol	Parameter		Min	Тур	Max	Unit	Test Conditions
V _{IH}	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs
V _{IL}	Input LOW Voltage				0.8	V	Guaranteed Input LOW Voltage for All Inputs
V_{IK}	Input Clamp Diode Vol	tage		-0.65	-1.5	V	$V_{CC} = MIN$, $I_{IN} = -18 \text{ mA}$
V _{OH}	Output HIGH Voltage		2.7	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table
V _{OL}	Output LOW Voltage			0.25 0.35	0.4	V V	I_{OL} = 4.0 mA V_{CC} = V_{CC} MIN, V_{IN} = V_{IL} or V_{IH} per Truth Table
l	Input HIGH Current	C ₀ Any A or B			20 40	μ Α μ Α	$V_{CC} = MAX$, $V_{IN} = 2.7 V$
l _{IH}	Input HIGH Current	C ₀ Any A or B		C	0.1	mA mA	V _{CC} = MAX, V _{IN} = 7.0 V
I _{IL}	Input LOW Current	C ₀ Any A or B	000	7	-0.4 -0.8	mA mA	V _{CC} = MAX, V _{IN} = 0.4 V
I _{OS}	Short Circuit Current (N	Note 1)	-20	10	-100	mA	V _{CC} = MAX
Icc	Power Supply Current Total, Output HIGH Total, Output LOW				34	mA	V _{CC} = MAX
			(,5)		39		

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

 C_1 – C_3 are generated internally C_0 is an external input C_4 is an output generated internally

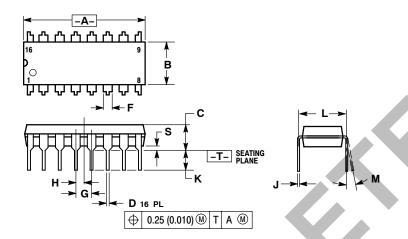
AC CHARACTERISTICS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

		Limits		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions		
t _{PLH} t _{PHL}	Propagation Delay, C_0 Input to Any Σ Output		16 15	24 24	ns			
t _{PLH} t _{PHL}	Propagation Delay, Any A or B Input to Σ Outputs		15 15	24 24	ns	C _I = 15 pF		
t _{PLH} t _{PHL}	Propagation Delay, C_0 Input to C_4 Output		11 11	17 22	ns	Figures 1 & 2		
t _{PLH} t _{PHL}	Propagation Delay, Any A or B Input to C ₄ Output		11 12	17 17	ns			



PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 648-08 **ISSUE R**



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

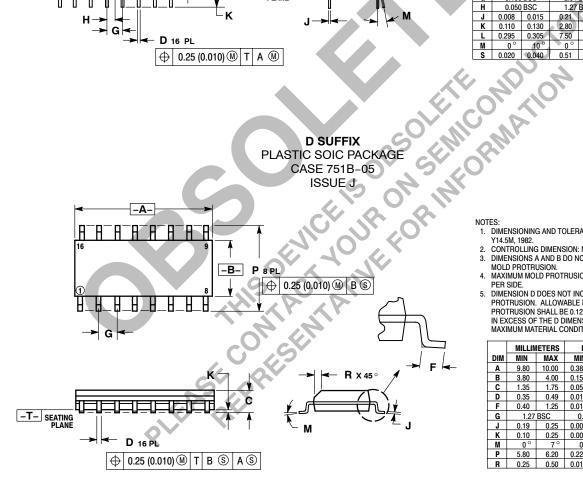
 2. CONTROLLING DIMENSION: INCH.

 3. DIMENSION L TO CENTER OF LEADS WHEN

- FORMED PARALLEL.
 DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
Ç	0.145	0.175	3.69	4.44	
Â	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0 °	10 °	
S	0.020	0.040	0.51	1.01	

D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 ISSUE J



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- PER SIDE.

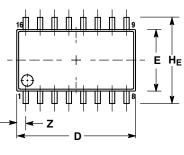
 5. DIMENSION D DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

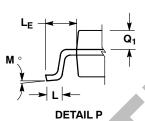
	MILLIN	IETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
C	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0°	7°	0°	7°	
P	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

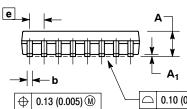
PACKAGE DIMENSIONS

M SUFFIX

SOEIAJ PACKAGE CASE 966-01 **ISSUE O**









NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD
 FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 THE LEAD WIDTH DIMENSION (b) DOES NOT
- INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES				
DIM	MIN	MAX	MIN	MAX				
Α		2.05	-35	0.081				
. A ₁	0.05	0.20	0.002	0.008				
ь	0.35	0.50	0.014	0.020				
C	0.18	0.27	0.007	0.011				
D	9.90	10.50	0.390	0.413				
E	5.10	5.45	0.201	0.215				
e	1.27	BSC	0.050 BSC					
ΗE	7.40	8.20	0.291	0.323				
L	0.50	0.85	0.020	0.033				
LE	1.10	1.50	0.043	0.059				
M	0 °	10°	0 °	10°				
Q_1	0.70	0.90	0.028	0.035				
Z		0.78		0.031				

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